

FIG. 1

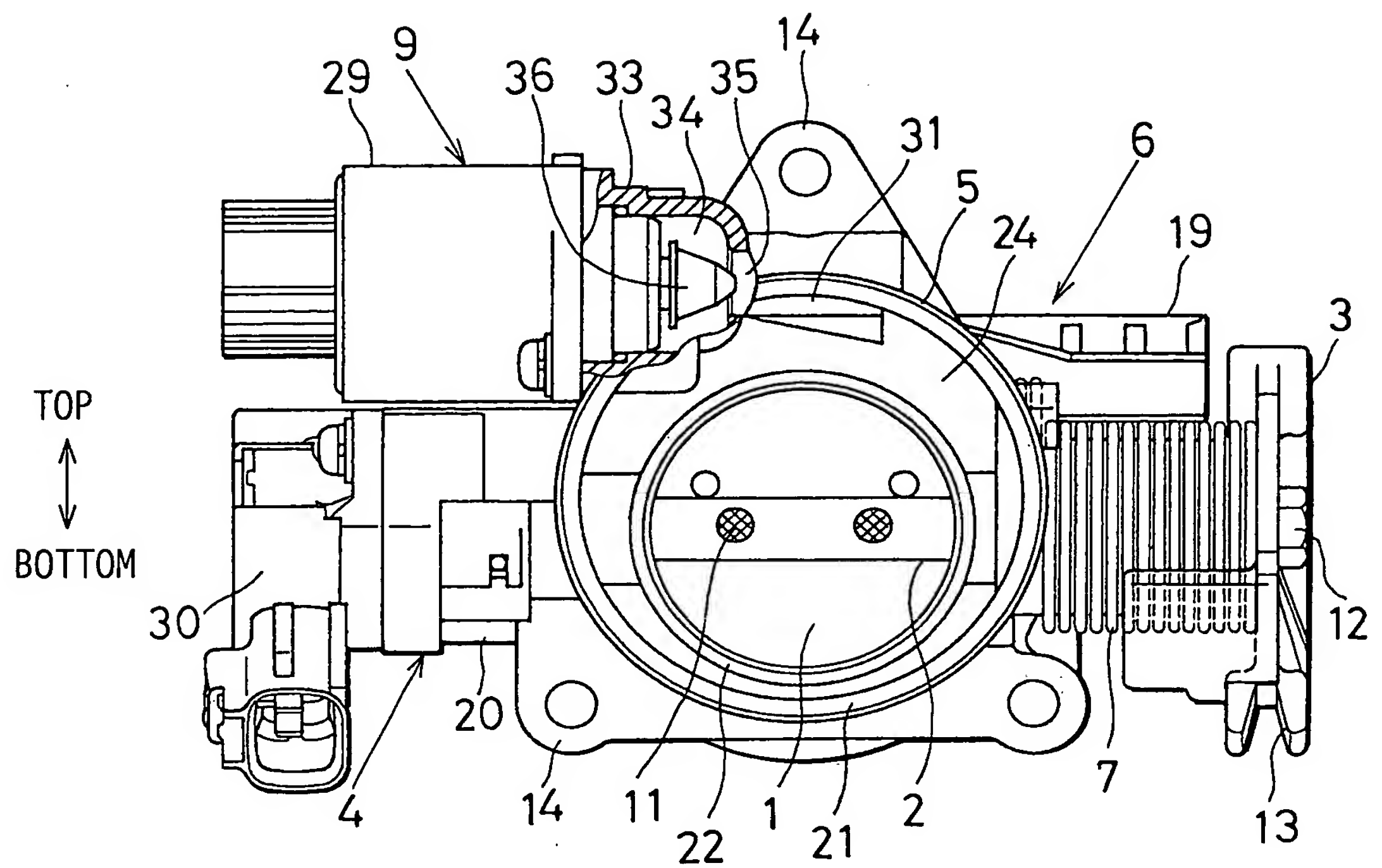


FIG. 2

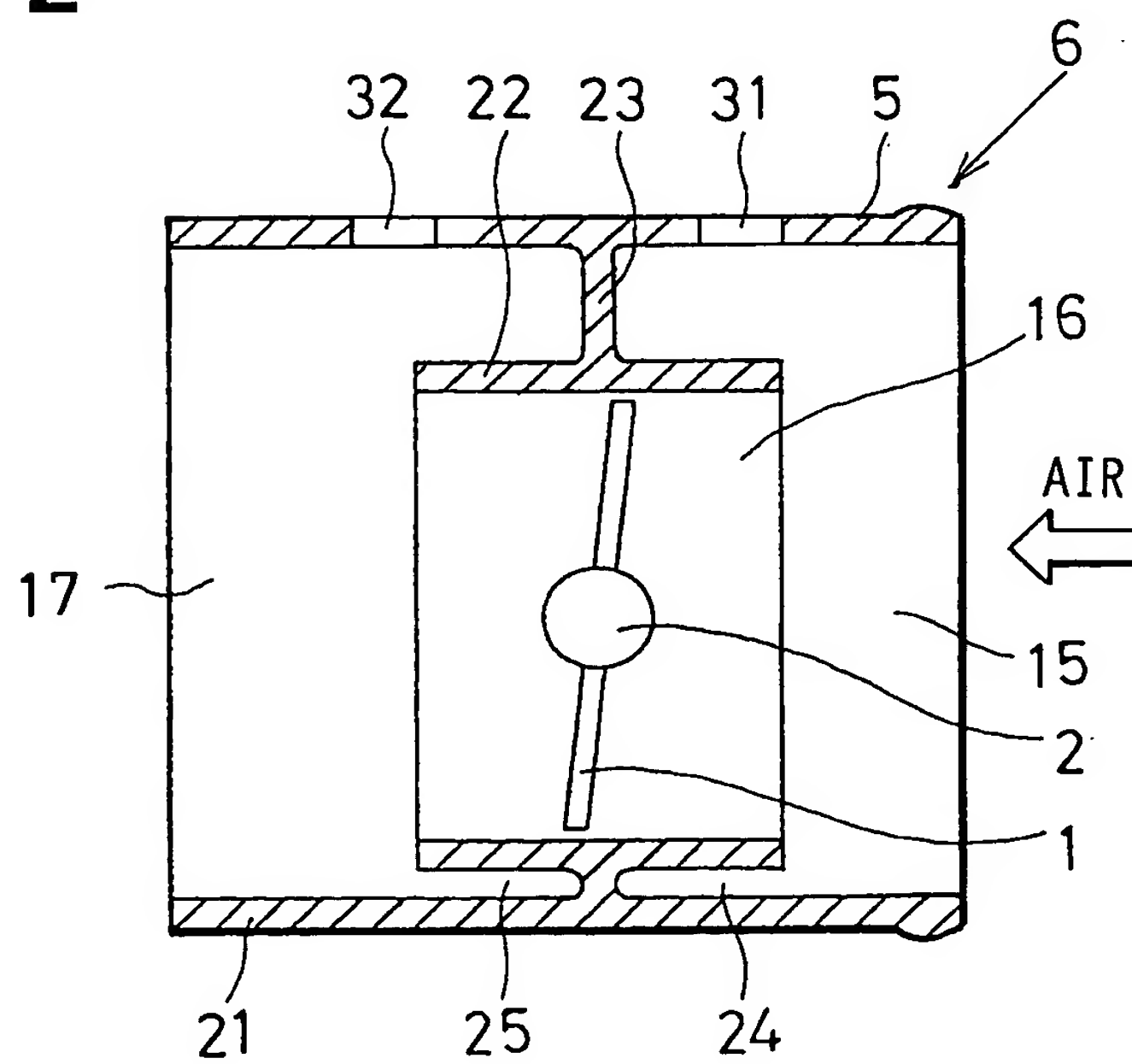


FIG. 3

9, 29, 33, 14, 24, 2, 5, 1, 6, 19, 3, 30, 4, 20, 14, 22, 24, 21, 37, 7, 13

TOP
↕
BOTTOM

FIG. 5

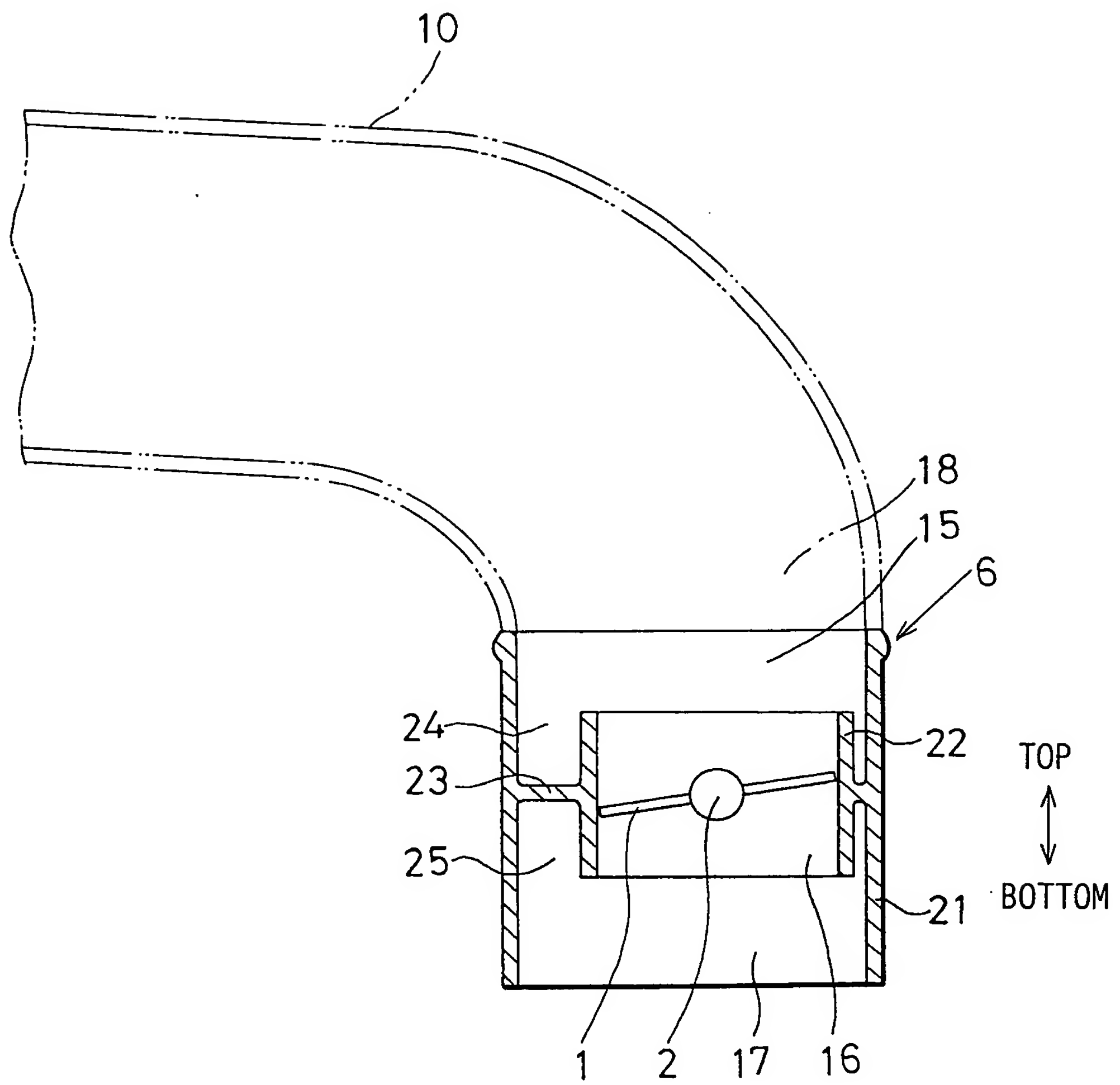


FIG. 6

FIG. 6 is a cross-sectional view of a semiconductor device. The device includes a substrate 1 with a central region 2. A central rod 1 passes through a circular feature 15. A horizontal dashed line represents the center of gravity, with labels C_i and C_o . A vertical double-headed arrow indicates the TOP and BOTTOM directions. A cross-hatched layer 5 is on top, and a cross-hatched layer 6 is on the right. A cross-hatched layer 17 is on the left. A cross-hatched layer 21 is at the bottom. A cross-hatched layer 22 is on the left side of the central region. A cross-hatched layer 23 is on the right side of the central region. A cross-hatched layer 24 is on the left side of the central region. A cross-hatched layer 25 is on the right side of the central region.

FIG. 1 is a perspective view of a vehicle seat belt buckle assembly. The assembly includes a buckle housing (1) with a central opening (2) and a latch (3) on the right. A tongue (4) is on the left. A spring (5) is connected to the latch. A strap (6) is shown passing through the buckle. Various components are labeled with numbers: 1, 2, 3, 4, 5, 6, 7, 9, 13, 14, 19, 20, 21, 22, 24, 29, 30, 33.

FIG. 8A

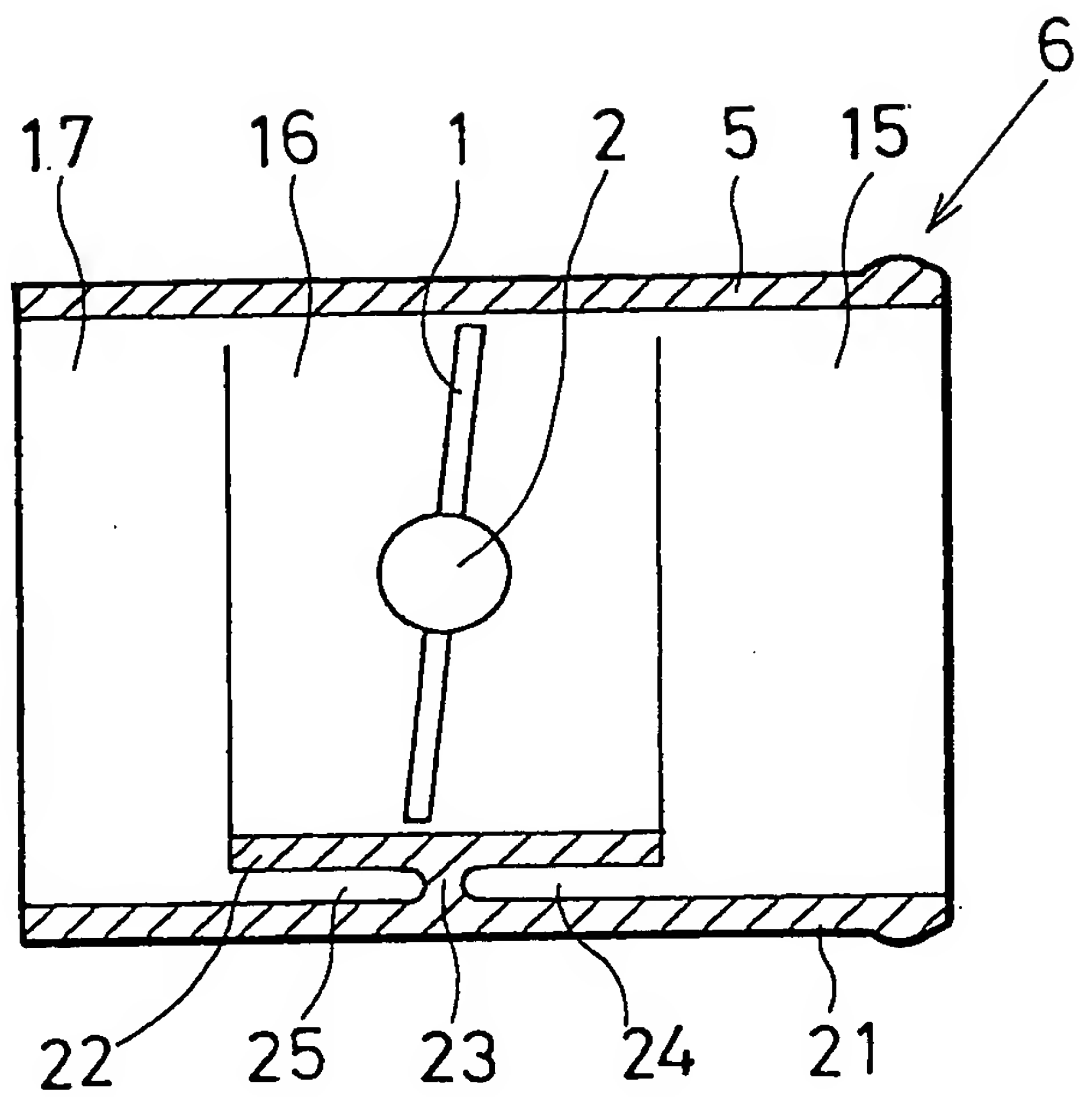


FIG. 8B

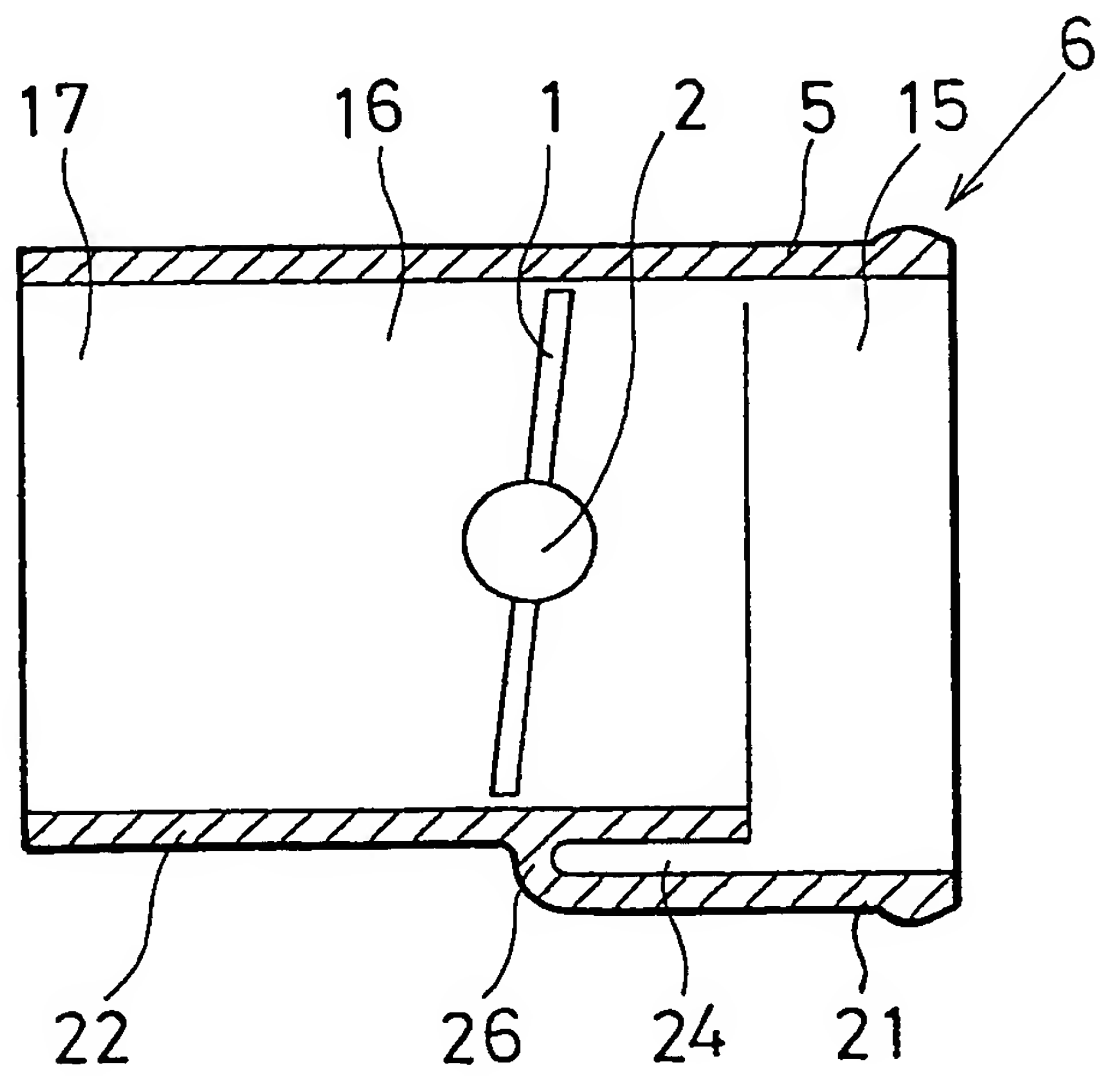


FIG. 9

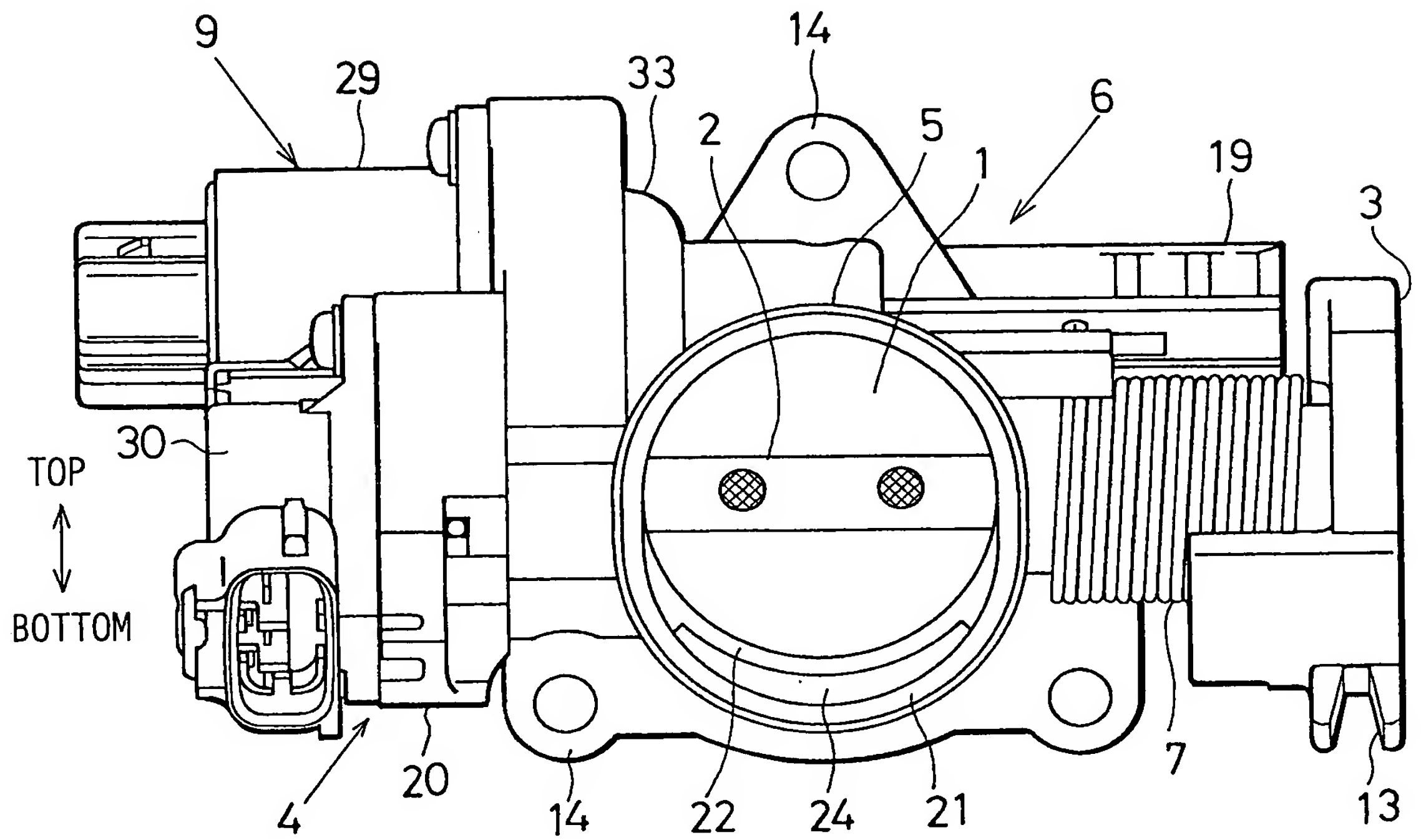


FIG. 10A

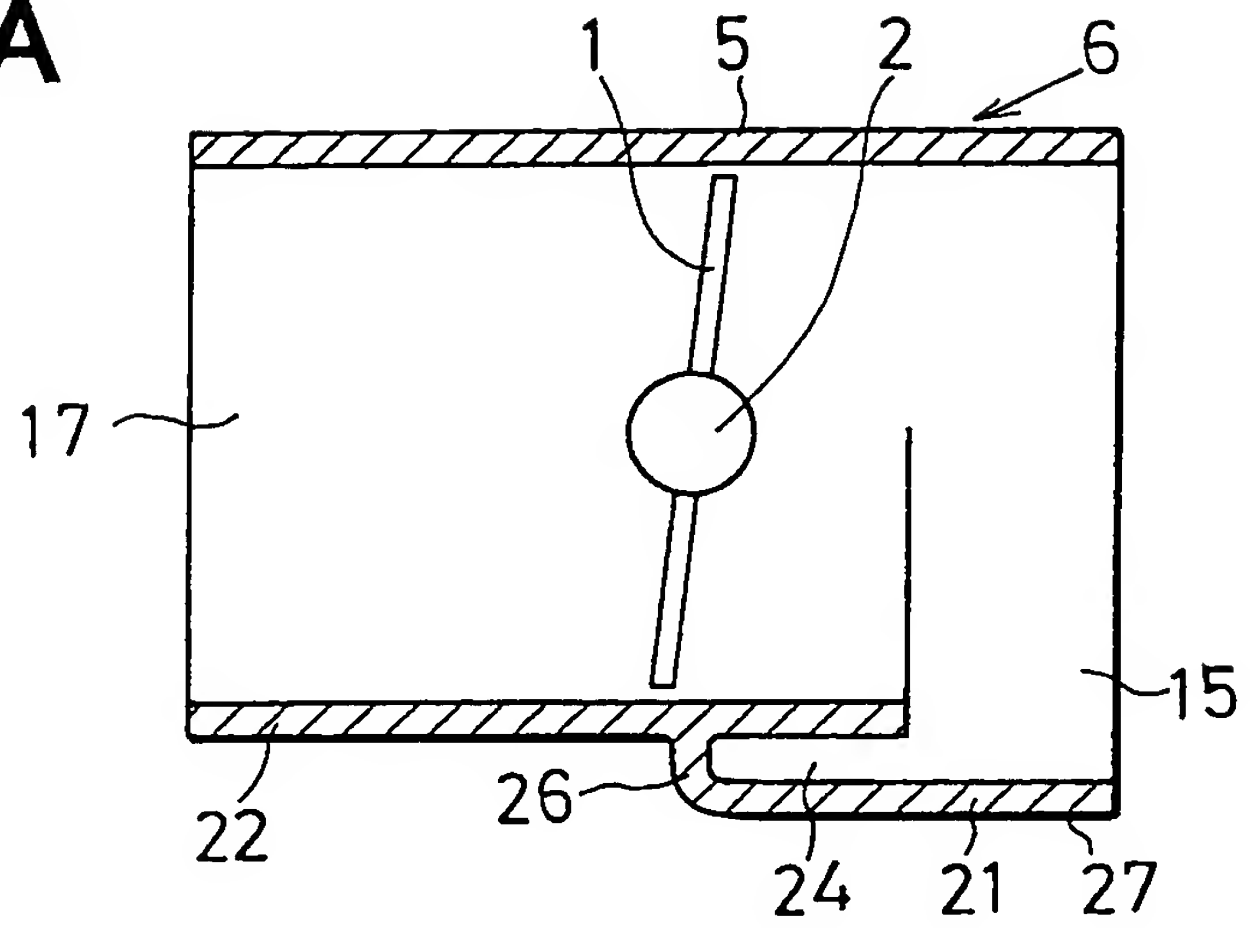


FIG. 10B

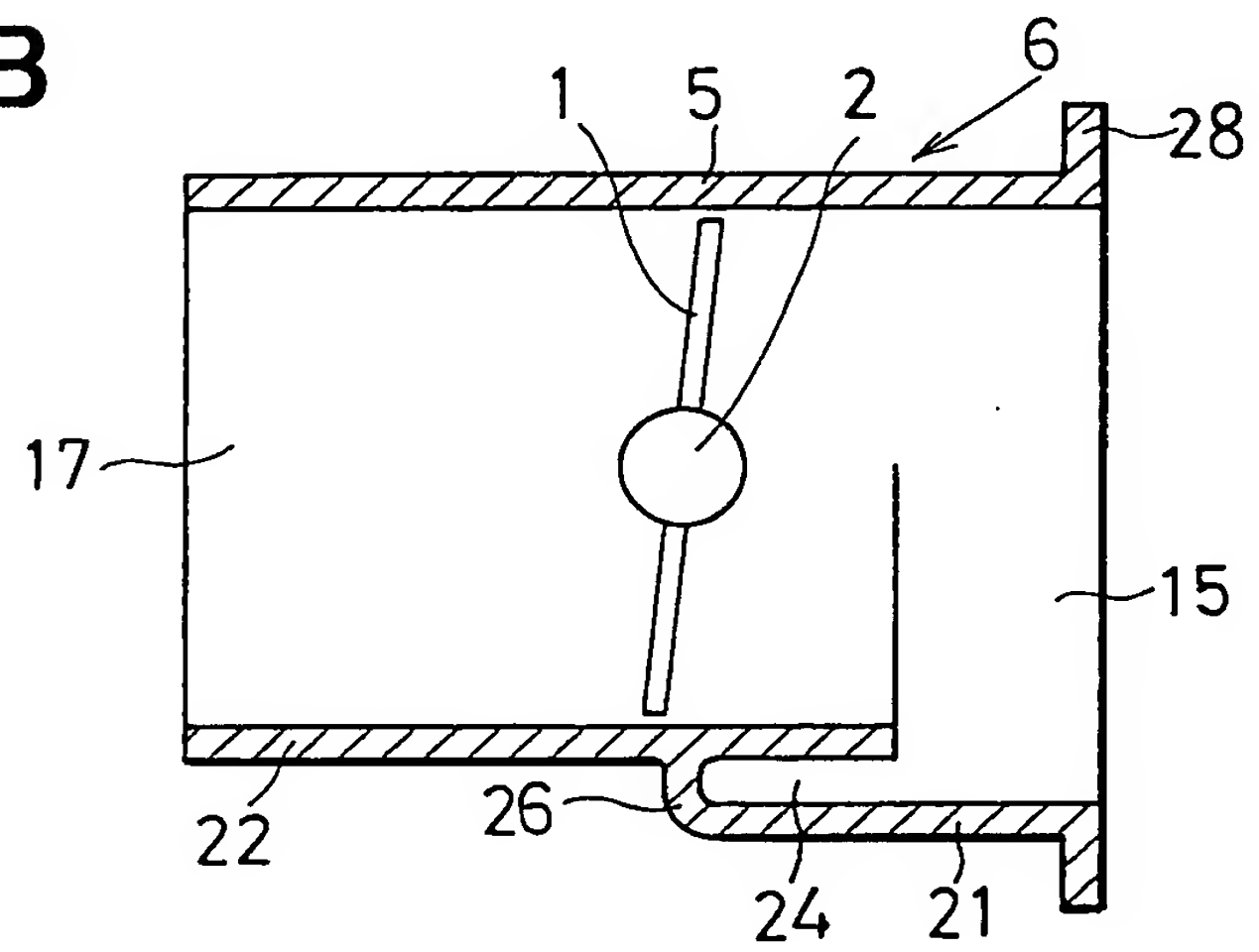
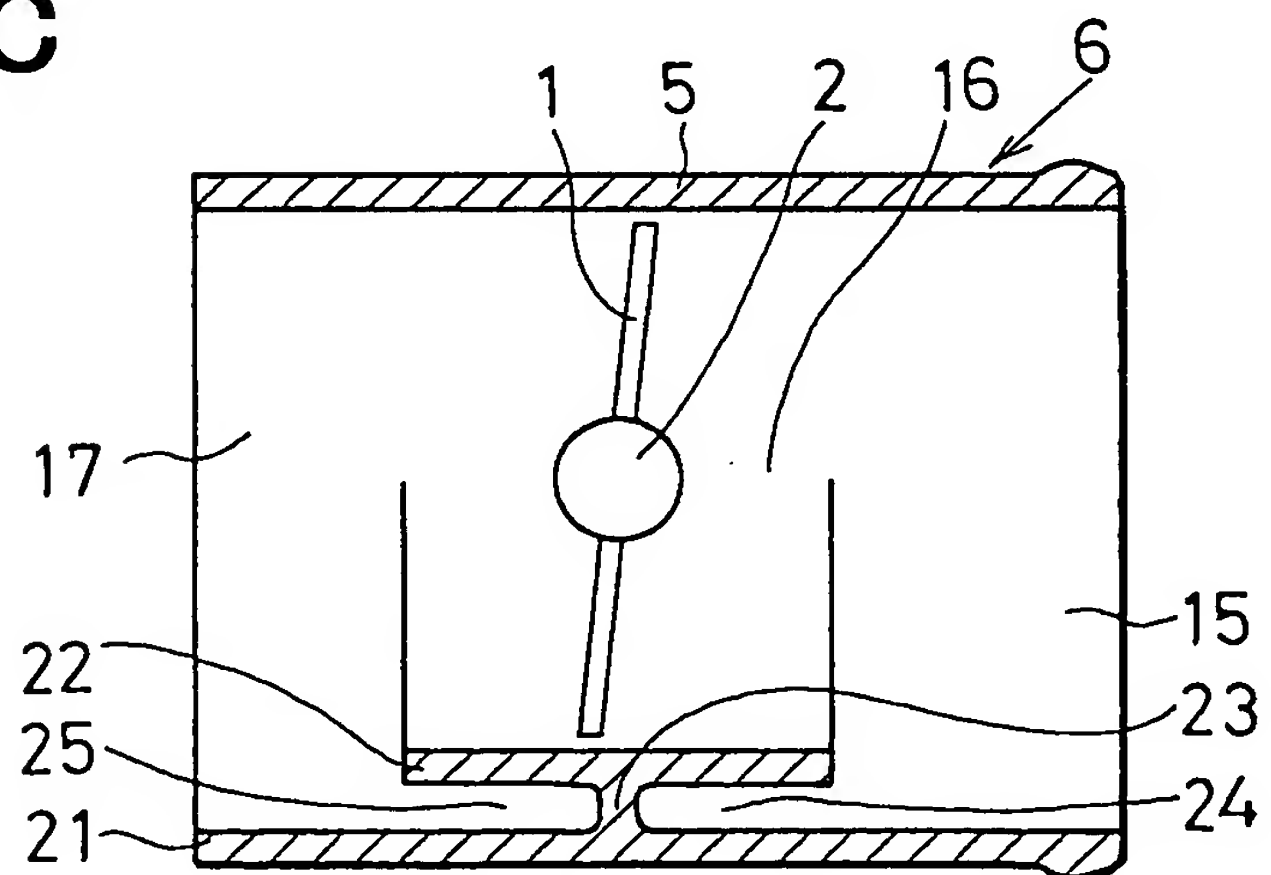


FIG. 10C



[illegible]

FIG. 13
RELATED ART

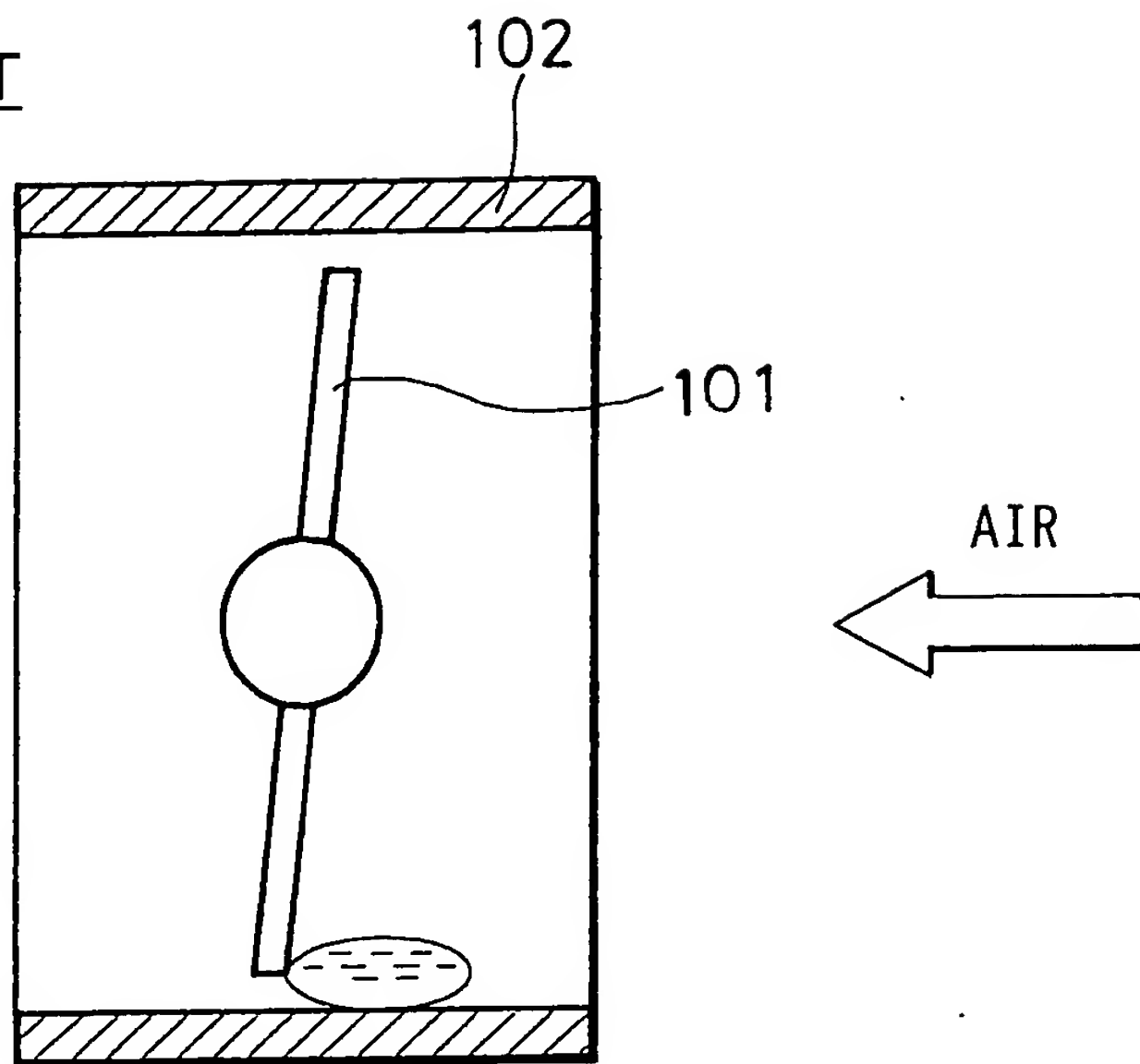


FIG. 14
RELATED ART

